LEAD ABSED PAINT INSPETION USVA – SEPULVEDA BUILDING 63 SEPULVEDA, CALIFORNIA

PREPARED FOR
UNITED STATES DEPARTMENT OF
VETERANS AFFAIRS
GREATER LOS ANGELES HEALTH SERVICES
11301 WILSHIRE BOULEVARD
LOS ANGELES, CA 90073
ATTN.: BEN K. SPIVEY

June 2, 2004

Environmental Engineering, Inc.

June 2, 2004 Contract No. V691P-6501 Obligation No. 691-C36189

Ben K. Spivey, Environment of Care USVA-Greater Los Angeles Health Services Bldg. No. 218, Room No. 308 11301 Wilshire Boulevard Los Angeles, CA 90073

LEAD BASED PAINT INSPECTION VA-SEPULVEDA BUILDING NO. 63 16111 PLUMMER STREET SEPULVEDA, CALIFORNIA

Environmental Engineering, Inc. on behalf of the United States Department of Veterans Affairs), performed a lead based paint inspection of the VA building 63 of Sepulveda Health Services (VA-Sepulveda facility in Los Angeles, California. Dr. Zainul Abedin, an accredited lead inspector conducted the testing on May 26, 2004, using a RMD XRF instrument in accordance with EPA guidelines for lead inspection. The action level as defined in HUD regulation 24 CFR 965.706@ (53FR 20803, June 6, 1988), is a lead concentration at or above 1.0 mg/cm² measured by XRF instrument.

The XRF instrument displayed the lead concentration in mg/cm² when its scanner was opened against the paint surfaces by pressing the shutter. A total of 98 measurement were made during XRF testing, and are organized in actual sequence by shot number, sample location, component, substrate, condition, and results for each component. Based on XRF testing, we conclude the following:

- The building components and paint surfaces observed during Site inspection were mostly intact, in general. Most doors, windows, walls, counters, ceilings, and other miscellaneous components had intact paint surfaces.
- Based on XRF measurements, there were no inconclusive results and, therefore, no paint chip or bulk samples were collected for confirmative analysis in the laboratory.
- Based on XRF measurements, undamaged lead based paint above the regulatory action level were discovered on selected window components at the Site.

Environmental Engineering, Inc.

Based on our findings and observation, we recommend the following actions at the Site.

 The lead-laden window components are friction surfaces and warrant removal or stabilization. These components in undamaged conditions should be removed or stripped during renovation or as soon as possible or for re-occupancy. Lead stripping should be done by properly trained and protected personnel. Future occupants, if any, should be warned of lead presence.

Environmental Engineering, Inc. conducted the asbestos inspection in accessible areas of the site. Other conditions may exist in inaccessible areas. The conclusions and recommendations describe only the conditions present at the time of our survey, in areas that were observed. This survey was performed in general accordance with the standards of care and diligence normally practiced by recognized consulting firms in performing services of a similar nature. If you have any questions concerning the methodology or the results of this survey, please contact us at (818) 547-1330.

Yours sincerely, ENVIRONMENTAL ENGINEERING, INC.,

Zainul Abedin, PhD, REA Project Manager

XRF Lead Based Paint Results VA-Sepulveda, BLDG-63 Inspection Date: 05/26/2004

Room	Shot	Loca	Compo	Subs	<u>Condi</u>	Results	Remarks
<u>No.</u>	<u>No</u>	<u>-tion</u>	<u>-nent</u>	<u>-trate</u>	<u>-tion</u>	mg/cm²	
108	1	Α	Wall	Р	1	-0.5	
"	2	В	Wall	Ρ	I	-0.3	
"	3	С	Wall	Р	ı	-0.2	
"	4	D	Wall	Р	1	-0.6	
u	5	В	Door Frame	W	1	-0.4	
	6	D	Window Sill	W	1	-0.3	
"	7	Ct	Ceiling	Р	1	-0.4	
109	8	Α	Wall	Ρ	1	-0.4	
"	9	В	Wall	Р	1	-0.5	
"	10	В	Door Frame	W	1	-0.2	
ıı	11	В	Door	W	1	-0.2	
	12	С	Wall	Р	1	-0.6	
"	13	D	Wall	Р	ı	-0.5	
	14	D	Door Frame	W	ı	-0.2	
	15	D	Door	W	l	-0.2	
u u	16	Ct	Ceiling	P	Ī	-0.3	
	17	Ct	HVAC	M	D	-0.3	
111	18	A	Wall	P	1	-0.3	
"	19	В	Wall	P	!	-0.4	
"	20	C	Wall	Р	1	-0.4	
"	21	D	Wall	Р	1	-0.2	
"	22	D	Shelf	M	D	-0.3	
4	23	В	Door	W	1	-0.1	
	24	В	Door Frame	W	1	0.7	
113	25	A	Wall	P	1	-0.4	
4	26	В	Wall	Р	1	-0.7	
"	27	C	Wall	P	1	-0.7	
"	28	D	Wall	P	1	-0.4	
"	29	Α	Window Sill	W	1	-0.4	
	30	A	Window Frame	W	1	-0.4	
	29	В	Window Sill	W	1	-0.3	
	30	В	Window Frame	W	1	0.7	
113A	31	A	Wall	P		-0.2	
u u	32	В	Wall	P	!	-0.3	
"	33	C	Wall	P	1	-0.4	
"	34	D	Wall	P	!	-0.2	
	35	Ct	Ceiling	Р	!	-0.4	
	36	В	Window sill	W	!	-0.4	
	37	В	Window Sash	W	!	1.0	
4	38	D	Door	W	!	-0.4	
	39	D	Door Frame	М	1	-0.4	
114	40	A	Wall	P	1	-0.2	
tt	41	В	Wall	Р	1	-0.3	
u	42 43	С	Wall	P P	1	-0.4	
44	43 44	D B	Wall		1	-0.3	
tt.			Window Sash	W	 	-0.3	
u .	45 46	В	Window Sash	W	1	1.2	
4	46 47	D D	Door Frame	W	1	0.3	
102A	47 48		Door Wall	VV P	i 1	-0.1 -0.2	
102A		A			-		
u	49 50	В	Wall	P P	1	-0.3	
u		C	Wall	P P	1	-0.3	
ű	51 52	D	Wall		1 .	-0.4 1.2	
6	52 53	В	Window Sash	W	1	1.2	
и	53 54	В	Window Sill	W	1	-0.1 0.4	
104A	54 55	D ^	Door Frame	M	1	-0.4 0.1	
10 4 /\	55 56	A	Wall Wall	WB WB	1	-0.1	
(I	56 57	B C	Wall	WB	1	-0.2 -0.4	
u	57 58	D	Wall	WB	1	-0.4 -0.1	
ıı	50 59	D	Window Sill	W	ı I	-0.1 -0.3	
u	60	D	Window Sash	W	1	-0.3 0.5	
	υυ	U	vviiluuw odsii	VV	1	0.5	

*	61	D	Door	W	1	-0.4
и	62	D	Door Frame	M	i	-0.4
u	63	В	Door Frame	М	i	-0.4
и	64	В	HVAC	М	Ĺ	-0.5
105	65	A	Wall	Р	i	-0.3
44	66	В	Wall	Р	Ì	-0.2
и	67	С	Wall	Р	ĺ	-0.1
"	68	D	Wall	Ρ	1	-0.4
tt	69	D	Window Sill	W	1	-0.3
tt	70	D	Window Sash	W	ı	1.3
iş.	71	В	Door	W	ı	-0.4
u	72	В	Door Frame	W	Ĺ	-0.2
и	73	В	HVAC	M	ĺ	-0.4
11	74	Ct	Ceiling	P	i	-0.8
105A	75	Α	Wall	P	í	-0.3
"	76	В	Wall	P	í	-0.2
"	77	С	Wall	P	í	-0.1
**	78	D	Wall	P	í	-0.3
u	79	D	Window Sill	w	í	-0.2
u	80	D	Window Sash	W	í	1.1
u	81	В	Door Frame	W	i	-0.3
II.	82	Ct	Ceiling	P	i	-0.6
107	83	Α	Wall	Р	i	-0.6
"	84	В	Wall	P P	i	-0.3
u	85	С	Wall	P	i	-0.4
"	86	D	Wall	P	i	-0.5
41	87	D	Window Sill	w	i	-0.3
u	88	D	Window Sash	W	í	1.0
tt	89	В	HVAC	M	í	-0.4
					•	0, 1
Exterior	90	В	Door (Entrance)	W	1	-0.2
tt	91	В	Door Frame	W	i	0.5
и	92	В	Ceiling	CN	i	0.2
"	93	В	Hand Rail	M	D	-0.2
	94	В	Window Sill	W	Ď	-0.2
"	95	В	Window Sash	W	Ď	2.2
16	96	A	Window Sash	W	D	4.0
u	97	D	Window Sash	W	Ď	2.8
44	98	D	Door	W	Ď	-0.2
				• •	_	0,2

Locations Locations

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XRF Lead Based Paint Measurements Substrate & Other Abbreviation Used